

MOSFET

600V CoolMOS™ SJ S7TA Power Device

CoolMOS™ S7TA enables the best price performance for low-frequency switching applications. The embedded temperature sensor increases junction temperature sensing accuracy and robustness while keeping an easy and seamless implementation. CoolMOS™ S7TA is optimized for "static switching" and high current applications. The new temperature sensor enhances S7A features, allowing the best possible utilization of the power transistor.

PG-HDSOP-22

Features

- Optimized price performance in low-frequency switching applications
- · High pulse current capability
- Seamless diagnostics at lowest system cost
- Temperature sense feature for protection and optimized thermal device utilization

Benefits

- Reduction of external sensing elements, hence a more compact design compared to electromechanical devices
- Increased system performance
- · Minimized conduction losses (reduce heat sink size)
- More reliability and longer system lifetime
- Shock & Vibration resistance; No contact arcing or bouncing

Potential applications

- Circuit breakers (HV eDisconnect switch, DC and AC low frequency switch, HV eFuse, on-board charger)
- · Line rectification in high-power/performance applications



Pin 4

Pin 1-2







Drain

Source

Product validation

Qualified according to AEC Q101

Please note: The source and sense source pins are not exchangeable. Their exchange might lead to malfunction. For paralleling 4pin MOSFET devices the placement of the gate resistor is generally recommended to be on the Driver Source instead of the Gate. For production part approval process (PPAP) release we propose to share application related information during an early design phase to avoid delays in PPAP release. Please contact Infineon sales office.

Table 1 Key Performance Parameters

Parameter	Value	Unit					
R _{DS(on),max}	22	mΩ					
$Q_{g,typ}$	150	nC					
V _{SD}	0.82	V					
Pulsed I _{SD} , I _{DS}	371	A					
ESD class (HBM)	2	JEDEC AEC Q101					

Type / Ordering Code	Package	Marking	Related Links
IPDQ60T022S7A	PG-HDSOP-22	60T022S7	see Appendix A

600V CoolMOS™ SJ S7TA Power Device IPDQ60T022S7A



Rev. 2.0, 2023-11-30

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1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 **Maximum MOSFET ratings**

Dougnatou	Symbol	Values			1114	Note / Took Condition
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Drain current rating ¹⁾	I _D	-	-	90 24	А	T _C =25°C T _C =140°C
Pulsed drain current ²⁾	I _{D,pulse}	-	-	371	А	T _C =25°C
Avalanche energy, single pulse	E AS	-	-	286	mJ	I_D =3.7A; V_{DD} =50V; see table 11
Avalanche current, single pulse	I _{AS}	-	-	3.7	Α	-
MOSFET dv/dt ruggedness ³⁾	dv/dt	-	-	20	V/ns	V _{DS} = 0V to 300V
Gate source voltage (static)	V _{GS}	-20	-	20	V	static
Gate source voltage (dynamic)	V _{GS}	-30	-	30	V	AC (f>1 Hz)
Power dissipation	P _{tot}	-	-	416	W	T _C =25°C
Storage temperature	$T_{ m stg}$	-55	-	150	°C	-
Operating junction temperature ¹⁾	T _j	-40	-	150	°C	-
Extended operating junction temperature	T _j	150	-	175	°C	≤50 h in the application lifetime
Mounting torque	-	-	-	n.a.	Ncm	-
Diode forward current rating	I _S	-	-	24	A	T _C =140°C Current is limited by T _{j max} = 150°C; Lower case temp does increase current capability
Diode pulse current ¹⁾	I _{S,pulse}	-	-	371	Α	T _C =25°C
Reverse diode dv/dt ⁴⁾	dv/dt	-	-	5	V/ns	$V_{\rm DS}$ =0 to 300V, $I_{\rm SD}$ <=23A, $T_{\rm j}$ =25°C see table 9
Maximum diode commutation speed	di _f /dt	-	-	800	A/μs	$V_{\rm DS}$ =0 to 300V, $I_{\rm SD}$ <=23A, $T_{\rm j}$ =25°C see table 9
Insulation withstand voltage	V _{ISO}	-	-	n.a.	V	-

 $^{^{1)}}$ Please consider the App Note: 600 V CoolMOS $^{\text{TM}}$ S7 with Temperature Sense for high delta T $_{\text{J}}$ usage $^{2)}$ Pulse width t_{p} limited by $T_{\text{j,max}}$ $^{3)}$ The dv/dt has to be limited by appropriate gate resistor $^{4)}$ Identical low side and high side switch

600V CoolMOS™ SJ S7TA Power Device





2 Thermal characteristics

 Table 3
 Thermal characteristics

Damamatan	Cumbal	Values			11:4	Nata / Taat Canditian
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	0.3	°C/W	-
Thermal resistance, junction - ambient	R _{thJA}	-	-	62	°C/W	device on PCB, minimal footprint
Thermal resistance, junction - ambient for SMD version	N thJA	-	45	55	°C/W	Device on 40mm*40mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70µm thickness) copper area. Tap exposed to air. PCB is vertical without air stream cooling.
Soldering temperature, reflow soldering allowed	T _{sold}	_	-	260	°C	reflow MSL1

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Electrical characteristics

at T_i=25°C, unless otherwise specified

Table 4 Static characteristics

The CoolMOS[™] mentioned in this datasheet shall not be operated in linear mode. For any questions in this regard, please contact Infineon sales office.

For applications with applied blocking voltage >400V, it is required that the customer

evaluates the impact of cosmic radiation effect in early design phase and contacts the Infineon sales office for the necessary technical support by Infineon

-	0		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	600	-	-	V	V_{GS} =0V, I_D =1mA
Gate threshold voltage	$V_{(GS)th}$	3.5	4.0	4.5	V	$V_{\rm DS}$ = $V_{\rm GS}$, $I_{\rm D}$ =1.43mA
Zero gate voltage drain current	I _{DSS}	-	- 50	5	μΑ	V _{DS} =600V, V _{GS} =0V, T _j =25°C V _{DS} =600V, V _{GS} =0V, T _j =150°C
Gate-source leakage current	I_{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	0.02 0.046	0.022	Ω	V _{GS} =12V, I _D =23A, T _j =25°C V _{GS} =12V, I _D =23A, T _j =150°C
Gate resistance	R _G	-	0.8	-	Ω	f=1MHz, open drain

Table 5 Dynamic characteristicsExternal parasitic elements (PCB layout) influence switching behavior significantly.

Stray inductances and coupling capacitances must be minimized.

For layout recommendations please use provided application notes or contact Infineon sales office.

Paramatan.	O. was book	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	5640	-	pF	V _{GS} =0V, V _{DS} =300V, f=250kHz
Output capacitance	Coss	-	89	-	pF	V _{GS} =0V, V _{DS} =300V, f=250kHz
Effective output capacitance, energy related ¹⁾	C _{o(er)}	-	302	-	pF	V _{GS} =0V, V _{DS} =0 to 300V
Effective output capacitance, time related ²⁾	C _{o(tr)}	-	2677	-	pF	I_D =constant, V_{GS} =0V, V_{DS} =0 to 300V
Output charge	Qoss	-	803	-	nC	V _{GS} =0V, V _{DS} =0 to 300V
Turn-on delay time	t _{d(on)}	-	30	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =23A, $R_{\rm G}$ =5.3 Ω ; see table 9
Rise time	t _r	-	6	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =23A, $R_{\rm G}$ =5.3 Ω ; see table 9
Turn-off delay time	$t_{ m d(off)}$	-	142	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =23A, $R_{\rm G}$ =5.3 Ω ; see table 9
Fall time	t _f	-	10	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =23A, $R_{\rm G}$ =5.3 Ω ; see table 9

 $^{^{1)}}$ $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 300V $^{2)}$ $C_{\text{o(tr)}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 300V

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 Table 6
 Gate charge characteristics

Parameter	Cymbal	Values			Unit	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	31	-	nC	$V_{\rm DD}$ =300V, $I_{\rm D}$ =23A, $V_{\rm GS}$ =0 to 12V
Gate to drain charge	Q_{gd}	-	49	-	nC	$V_{\rm DD}$ =300V, $I_{\rm D}$ =23A, $V_{\rm GS}$ =0 to 12V
Gate charge total	Qg	-	150	-	nC	$V_{\rm DD}$ =300V, $I_{\rm D}$ =23A, $V_{\rm GS}$ =0 to 12V
Gate plateau voltage	V _{plateau}	-	5.4	-	V	$V_{\rm DD}$ =300V, $I_{\rm D}$ =23A, $V_{\rm GS}$ =0 to 12V

Table 7 Reverse diode characteristics

Danamatan	Symbol	Values			11	Nata / Tank Oan Hillian
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Diode forward voltage	V _{SD}	-	0.82	-	V	V _{GS} =0V, I _F =23A, T _j =25°C
Reverse recovery time	t _{rr}	-	410	-	ns	V_R =300V, I_F =23A, di_F/dt =100A/ μ s; see table 8
Reverse recovery charge	Qrr	-	10	-	μC	V_R =300V, I_F =23A, di_F/dt =100A/ μ s; see table 8
Peak reverse recovery current	I _{rrm}	-	48	-	А	V_R =300V, I_F =23A, di_F/dt =100A/ μ s; see table 8

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4 Temperature Sensor parameters at T_j =25°C, unless otherwise specified

Table 8 **Maximum ratings**

Barranatan	Cumbal	Values			11	Note / Took Operation
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Repetitive Peak Reverse Voltage	V_{RRM}	-	-	15	V	<i>I</i> _R = 100 μA
Sensor forward current	I _F	-	-	5	mA	-
Repetitive peak forward current	I _{F_pulse}	-	-	25	mA	t _{pulse} = 1 ms, T _{period} = 10 ms
Non-repetitive peak forward current	I _{FSM}	- - -	- - -	1.5 0.2 0.1	A	T_C = 25°C, t_{pulse} = 1 μs T_C = 25°C, t_{pulse} = 1 ms T_C = 25°C, t_{pulse} = 1 s
Junction Temperature	T _j	-	-	185	°C	t < 50h, Sensor only

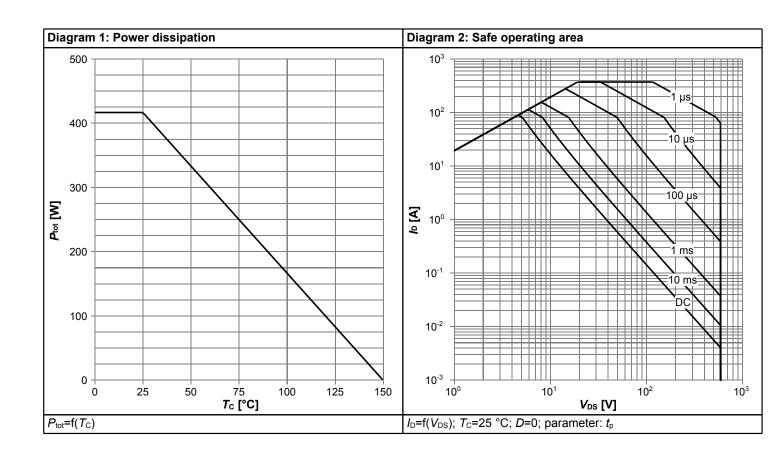
Table 9 **Electrical characteristics**

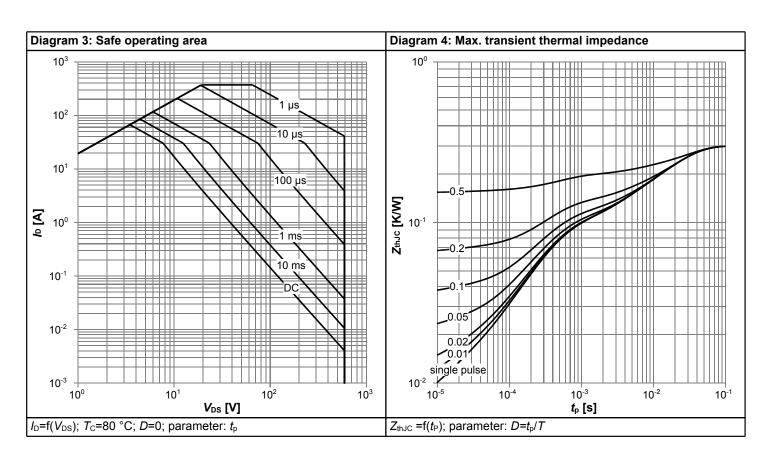
Douglaston	Cymphol	Values			11!4	Nata / Tarak O and Hitiara	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Sensor forward voltage ¹⁾	V _{F_25}	1.5601 - - 2.0665	1.6019 1.8103 1.9806 2.0966	-	V	$T_{j} = 25^{\circ}C$, $I_{F} = 10 \mu A$ $T_{j} = 25^{\circ}C$, $I_{F} = 50 \mu A$ $T_{j} = 25^{\circ}C$, $I_{F} = 200 \mu A$ $T_{j} = 25^{\circ}C$, $I_{F} = 500 \mu A$	
Sensor forward voltage temperature coefficient	тс	- - -	5.9644 5.5880 5.2287 5.0135	-	mV/K	$\begin{array}{c} 25^{\circ}C \leq T_{j} \leq 175^{\circ}C, \; I_{F} = 10 \; \mu A \\ 25^{\circ}C \leq T_{j} \leq 175^{\circ}C, \; I_{F} = 50 \; \mu A \\ 25^{\circ}C \leq T_{j} \leq 175^{\circ}C, \; I_{F} = 200 \; \mu A \\ 25^{\circ}C \leq T_{j} \leq 175^{\circ}C, \; I_{F} = 500 \; \mu A \end{array}$	
Sensor forward voltage	V _{F_175}	-	0.7072 0.9721 1.1963 1.3445	- -	V	$T_{j} = 175^{\circ}\text{C}, \ I_{F} = 10 \ \mu\text{A}$ $T_{j} = 175^{\circ}\text{C}, \ I_{F} = 50 \ \mu\text{A}$ $T_{j} = 175^{\circ}\text{C}, \ I_{F} = 200 \ \mu\text{A}$ $T_{j} = 175^{\circ}\text{C}, \ I_{F} = 500 \ \mu\text{A}$	
Reverse leakage current	I _R	-	-	1 20	μA	$V_R = 10V, T_j = 25^{\circ}C$ $V_R = 10V, T_j = 175^{\circ}C$	
Sensor G Capacitance	C _{GTS}	-	4.2	-	pF	f = 1 MHz, I _F = 50 μA	
Sensor Capacitance	C _{STS}	-	4.8	-	pF	f = 1 MHz, I _F = 50 μA	
Anode-Drain Capacitance	C _{DTS}	-	0.5	-	pF	f = 1 MHz, V _{DS} = 0 V	

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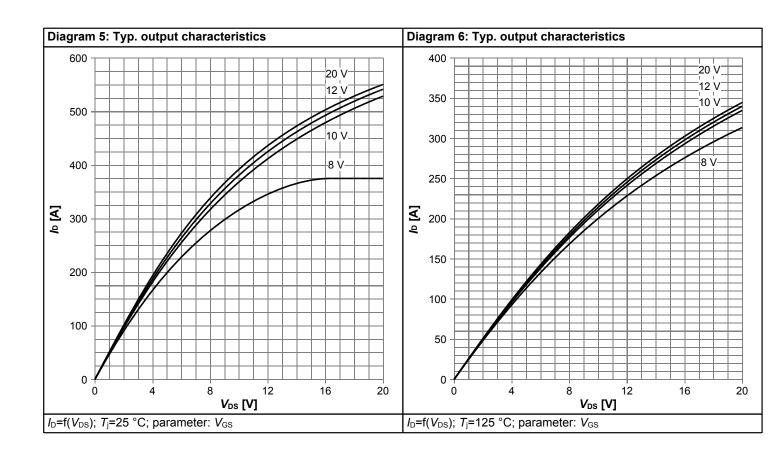


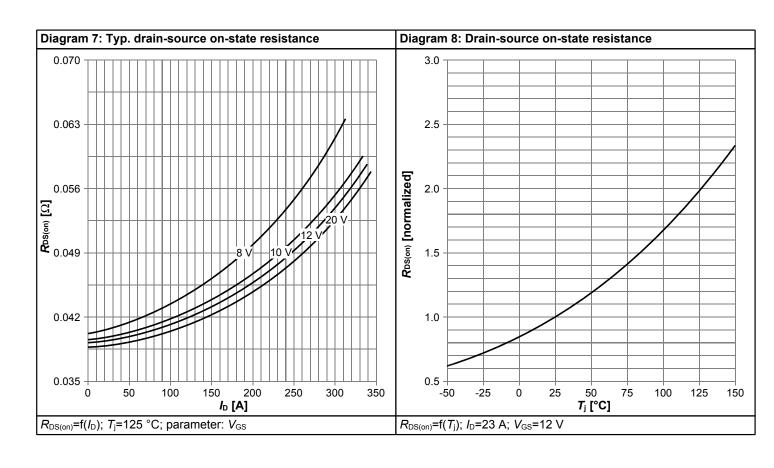
5 Electrical characteristics diagrams



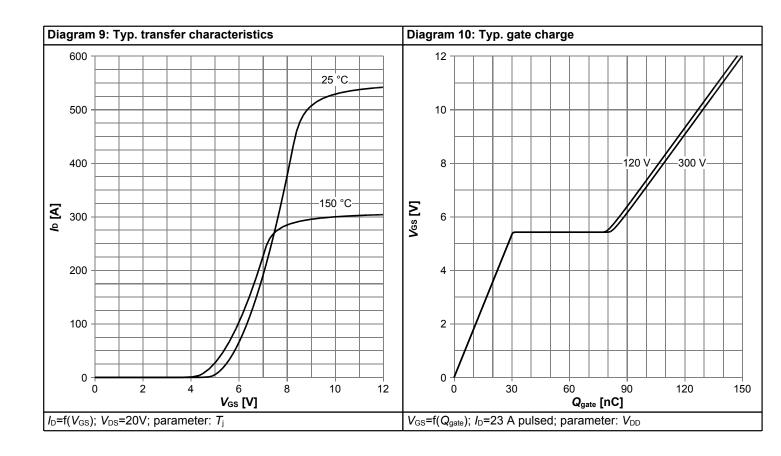


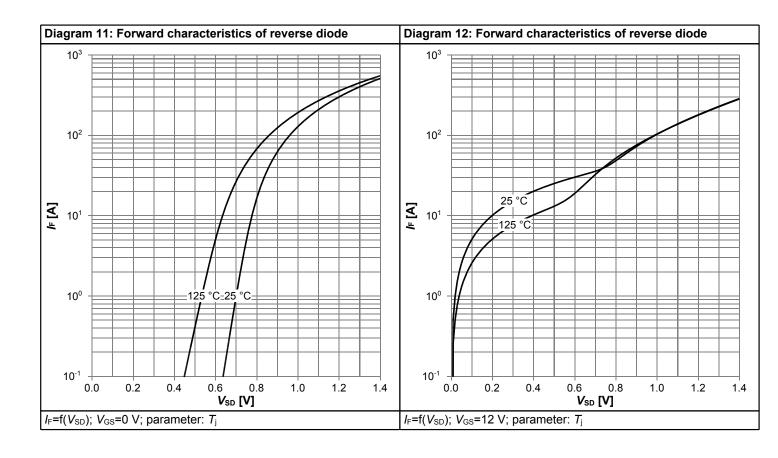




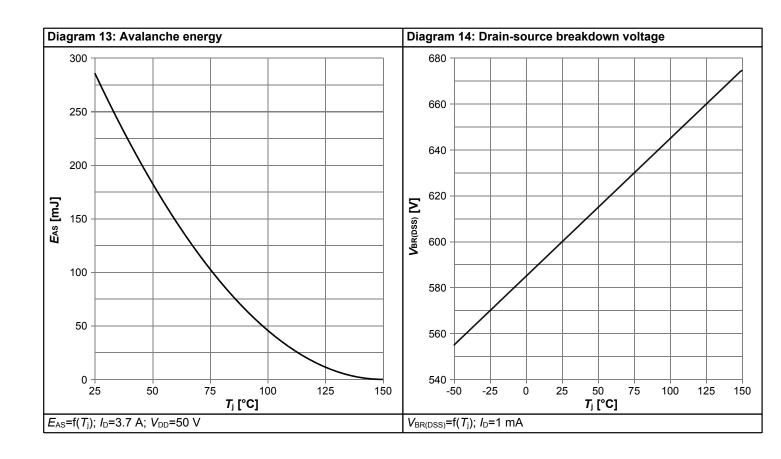


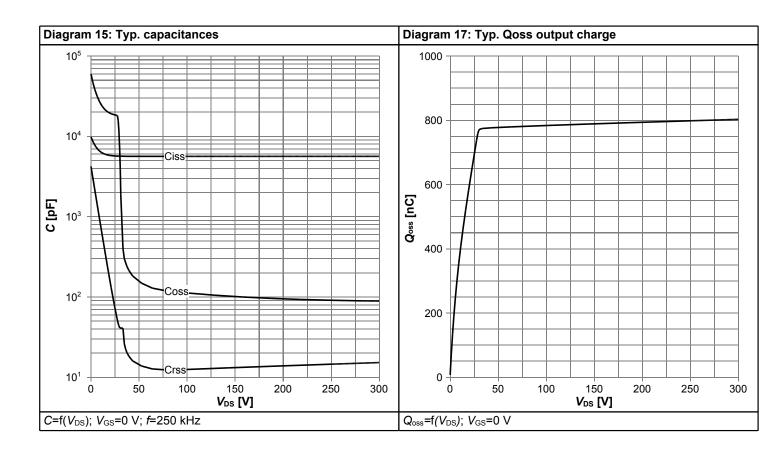




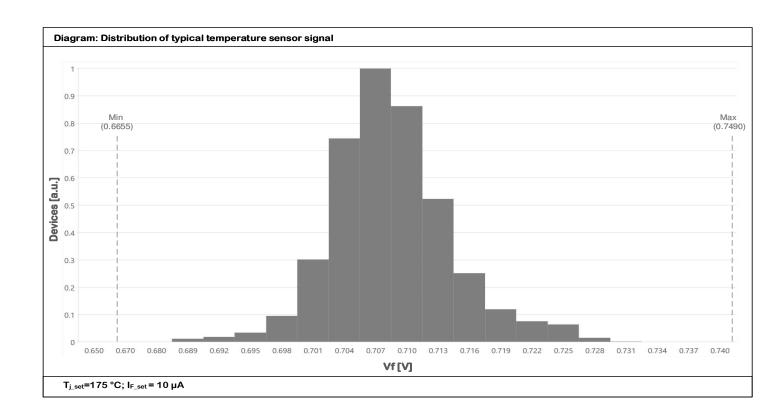














6 Test Circuits

Table 10 Diode characteristics

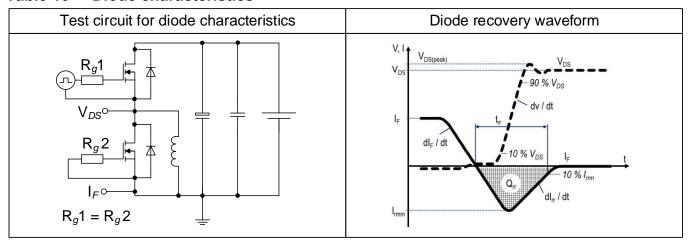


Table 11 Switching times (ss)

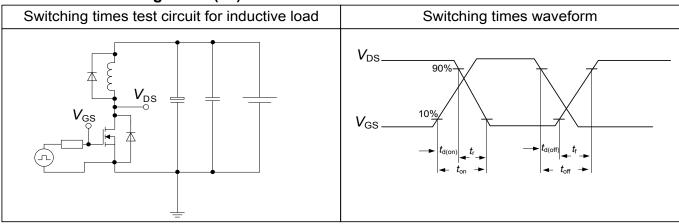
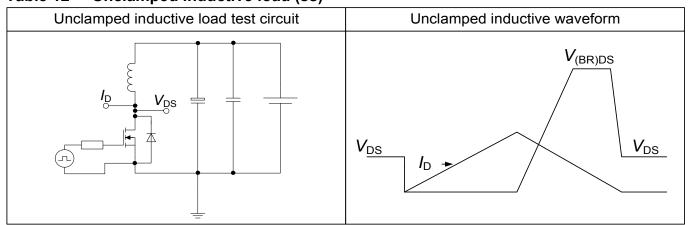


Table 12 Unclamped inductive load (ss)





7 Package Outlines

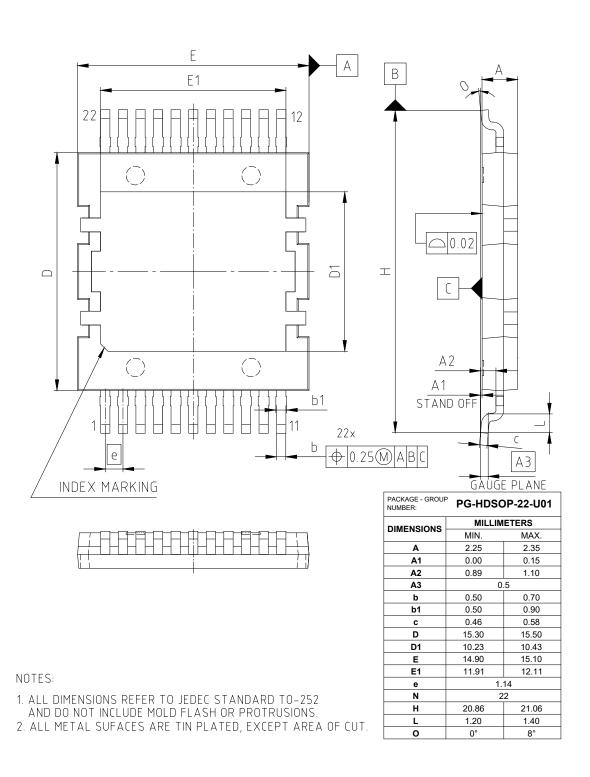


Figure 1 Outline PG-HDSOP-22, dimensions in mm

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8 Appendix A

Table 13 Related Links

• IFX CoolMOS™ S7TA Webpage: www.infineon.com

• IFX CoolMOS™ S7TA application note: www.infineon.com

• IFX CoolMOS™ S7TA simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

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IPDQ60T022S7A



Revision History

IPDQ60T022S7A

Revision: 2023-11-30, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)				
2.0	2023-11-30	Release of final version				

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